



## Application Data Sheet

### Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD_R?::	None
Number of CD disks::	
Number of copies of CDs::	
Sequence Submission::	No
Computer Readable Form (CRF)?::	No
Title::	SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE
Attorney Docket Number::	10873.851US01
Request For Early Publication::	No
Request For Non-Publication::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	15
Small Entity::	No
Latin Name::	
Variety Denomination Name::	
Petition Included::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	
Secrecy Order in Parent Appl.?::	No

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TC 2800 MAIL ROOM

RECEIVED  
MAR 22 2002

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APR 29 2002  
Technology Center 210

Initial 12/05/01

## Applicant Information

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Hiroaki  
Middle Name::  
Family Name:: Asada  
Name Suffix::  
City of Residence:: Takatsuki  
State or Province of Residence:: Osaka  
Country of Residence:: Japan  
Street of mailing address:: 6-10-1-403, Makami-cho  
City of mailing address:: Takatsuki  
State or Province of mailing address:: Osaka  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 569-1121

## Correspondence Information

Correspondence Customer Number:: 23552

## Representative Information

Representative Customer Number::	23552
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## Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2001-083422	03/22/01	Yes

Initial 12/05/01


### Assignee Information

Assignee Name:: Matsushita Electric Industrial Co., Ltd.  
 Street of mailing address:: 1006-banchi, Oaza-Kadoma  
 City of mailing address:: Kadoma  
 State or Province of mailing address:: Osaka  
 Country of mailing address:: Japan  
 Postal or Zip Code of mailing address:: 571-8501

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